



Product Change Notification

Change Notification #: 116494 - 00
Change Title: Intel® XWAY™ WAV300 PSB8231, Intel® XWAY™ WAV300 PSB8221 and Intel® XWAY™ WAV300 PSB8301 Wi-Fi Chipsets, PCN 116494-00, Product Discontinuance, End of Life
Date of Publication: September 21, 2018

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	April 30, 2019
Orders are Non-Cancelable and Non-Returnable After:	October 31, 2019
Last Product Discontinuance Shipment Date:	October 31, 2019
Technical Support Service Ends:	October 31, 2019

Description of Change to the Customer:

Intel® XWAY™ WAV300 PSB8231, Intel® XWAY™ WAV300 PSB8221 and Intel® XWAY™ WAV300 PSB8301 Wi-Fi Chipset SKUs listed in the products affected table are being discontinued and unavailable for additional orders after the "Last Product Discontinuance Order Date" (see "Key Milestones" above).

Customer Impact of Change and Recommended Action:

Please determine your remaining demand for the products listed in the "Products Affected/Intel Ordering Codes" table and place your "Last Product Discontinuance Order" in accordance with the "Key Milestones" listed above.

Please contact your local Intel Field Sales Representative if you have any further questions about this End of Life notice.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#	Stepping
Intel® XWAY™ WAV300 PSB8231 Wi-Fi Chipset	PSB8231EL	S LLEJ	946758	A1
Intel® XWAY™ WAV300 PSB8221 Wi-Fi Chipset	PSB8221EL	S LLEG	946769	A1
Intel® XWAY™ WAV300 PSB8301 Wi-Fi Chipset	PSB8301V	S LLEM	946944	A1

PCN Revision History:

Date of Revision: September 21, 2018	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Europe Email: eccb@intel.com

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